

< GaN HEMT for satellite communication (SATCOM) earth station>

MGFK48G2732A

Ku band internally matched power GaN HEMT 12.75 - 13.25 GHz BAND / 70W Multi-carrier operable

DESCRIPTION

The MGFK48G2732A, GaN HEMT with an N-channel schottky gate, is designed for Ku-band applications with multi-carrier operation.

: VDS=24V

FEATURES

- High voltage operation
- High output power
- High efficiency

: Po=48.3dBm (TYP.) @Pin=42dBm

- : PAE=31% (TYP.) @́Pin=42dBm
- Wide offset frequency : Up to 400MHz
- Designed for use in Class AB linear amplifiers

APPLICATION

Amplifier for Ku-band SATCOM

QUALITY

General & Industrial

Packaging

• Individual case

RECOMMENDED BIAS CONDITIONS

• Vds=24V • Ids=1.44A • Rg=13.3Ω

Absolute maximum ratings (Ta=25°C)

| Symbol | Parameter | Ratings | Unit |
|--------|----------------------------|-------------|------|
| Vgso | Gate - Source Voltage | -10 | V |
| Vds | Drain - Source Voltage | 27 | V |
| IGF | Forward Gate Current | 100 | mA |
| IGR | Reverse Gate Current | -24 | mA |
| τ | Screw Torque | 49 | N∙cm |
| PT*1 | Total Power Dissipation | 225 | W |
| Pin | Input Power | ≦44 | dBm |
| Tch | Channel Temperature | 250 | °C |
| Tstg | Storage Temperature | -55 to +125 | °C |
| Тс | Case Operating Temperature | 100 | °C |

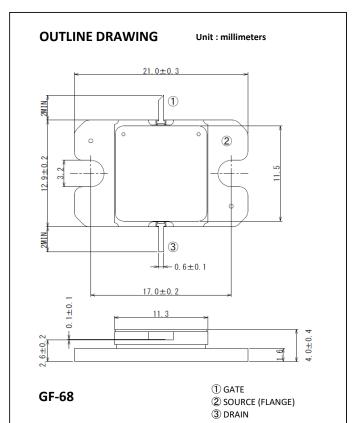
*1:Tc=25°C

Recommended operating Condition

| Symbol | Parameter | Limit | Unit |
|--------|----------------------------|-------|------|
| Тс | Case Operating Temperature | 85 | °C |
| Vds | Drain - Source Voltage | 24 | V |
| IDQ | Drain Quiescent Current | 1.44 | А |
| Rg | Gate Resistance | 13.3 | Ω |

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Electrical characteristics (Ta=25°C)

| Parameter | Symbol | Test conditions | | Limits | | Unit |
|---------------------------------------|--------------|---|------|--------|------|------|
| | | | Min. | Тур. | Max. | |
| Pinch-off Voltage | VGS(off) | Vds=24V,ID=28.8mA | -1 | - | -5 | V |
| Output Power | Pout *2 | Vds=24V,IDQ=1.44A f=12.75 ,13.00, 13.25GHz -*2 : Pin=42dBm *3 : Pin=27dBm | 47.3 | 48.3 | - | dBm |
| Power Added Efficiency | PAE *2 | | - | 31 | - | % |
| Linear Power Gain | GLP *3 | | 9 | 11 | - | dB |
| 3 rd Order Intermodulation | IM3 | Two-tone Test,Po=39.3dBm (Single Carrier Level) Δ f=5MHz(IM3), Δ f=200MHz(IM3-2), | -25 | - | - | dBc |
| distortion | IM3-2 | | -24 | - | - | |
| | IM3-3 | Δ f=400MHz(IM3-3) | -24 | - | - | |
| Thermal Resistance | Rth(ch-c) *4 | Δ Vf method | - | 0.8 | 1.0 | °C/W |

*4 :Channel-case

Specifications are subject to change without notice

| ESD *5 | Class 0 | -199~ | |
|---|---------|-------|--|
| *5 :Based on EIAJ ED-4701 C-111A(C=100pF,R=1.5kΩ) | | | |

Keep safety first in your circuit designs!

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